

SOLE/JOINT

DECLARATION AND POWER OF ATTORNEY

As a below named inventor, I hereby declare that my residence, post office address and citizenship are as stated below next to my name: that I verily believe I am the original, first and sole inventor (if only one name is listed below) or a joint inventor (if plural names are listed below) of the subject matter claimed and for which a patent is sought in the application entitled:

METHOD FOR CUTTING HONEYCOMB CORE

W	hich application is:				
[X] the attached application	[] appli	ication Serial No	,	
_ (f	X] the attached application for original application)	filed	, and ame	nded on	
j	•		(for declaration not acco	mpanying application)	
		stand the contents of th	e specification of the above-ident	ified application, including the	claims
Ų Lias	s amended by any amendment	referred to above; that	I acknowledge my duty to disclo	se information of which I am a	ware
Ö w	hich is material to the patenta	bility of this applicatio	n under 37 C.F.R. 1.56, and that I	hereby claim foreign priority	benefits
u A	nder Title 35, United States C	ode §119, §172 or §36	5 of any foreign application(s) for	patent or inventor's certificate	listed
be	elow and have also identified	on said list any foreign	application for patent or inventor	's certificate on this invention	having a
fi.	ling date before that of the ap	plication on which prio	rity is claimed:		
l.					
H.A. from the	Application Number	Country	Filing Date	Priority Claimed (yes or no)	
i	2000-251557	Japan	August 22, 2000	Yes	

I hereby claim the benefit of Title 35, United States Code §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in a listed prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge my duty to disclose any information material to the patentability of this application under 37 C.F.R. 1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application.

Application Serial No.	Filing Date	Status (patented, pending, abandoned)

I hereby appoint John H. Mion, Reg. No. 18,879; Donald E. Zinn, Reg. No. 19,046; Thomas J. Macpeak, Reg. No. 19,292; Robert J. Seas, Jr., Reg. No. 21,092; Darryl Mexic, Reg. No. 23,063; Robert V. Sloan, Reg. No. 22,775; Peter D. Olexy, Reg. No. 24,513; J. Frank Osha, Reg. No. 24,625; Waddell A. Biggart, Reg. No. 24,861; Robert G. McMorrow, Reg. No. 19,093; Louis Gubinsky, Reg. No. 24,835; Neil B. Siegel, Reg. No. 25,200; David J. Cushing, Reg. No. 28,703; John R. Inge, Reg. No. 26,916; Joseph J. Ruch, Jr., Reg. No. 26,577; Sheldon I. Landsman, Reg. No. 25,430; Richard C. Turner, Reg. No. 29,710; Howard L. Bernstein, Reg. No. 25,665; Alan J. Kasper, Reg. No. 25,426; Kenneth J. Burchfiel, Reg. No. 31,333; Gordon Kit, Reg. No. 30,764; Susan J. Mack, Reg. No. 30,951; Frank L. Bernstein, Reg. No. 31,484; Mark Boland, Reg. No. 32,197; William H. Mandir, Reg. No. 32,156; Scott M. Daniels, Reg. No. 32,562; Brian W. Hannon, Reg. No. 32,778 and Abraham J. Rosner, Reg. No. 33,276, my attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith, and request that all correspondence about the application be addressed to SUGHRUE, MION, ZINN, MACPEAK & SEAS, 2100 Pennsylvania Avenue, N.W., Washington, D.C. 20037.

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

FIRST INVENTOR

Full Name	Signature	Date
Akira HIRAYAMA	Shira I din	ayma August 13, 2001
Residence		Citizenship
Saitama-ken, Japan		Japan
Post Office Address		